



Product Change Notification

Change Notification #: 116325 - 00
Change Title: Intel® Dual Band Wireless-AC 3165
 SKU: 3165.NGWG
 SKU: 3165.NGWG.S,
 PCN 116325-00, Label,
 Label Update
Date of Publication: June 26, 2018

Key Characteristics of the Change:
 Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 11, 2018
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Description of Change to the Customer:

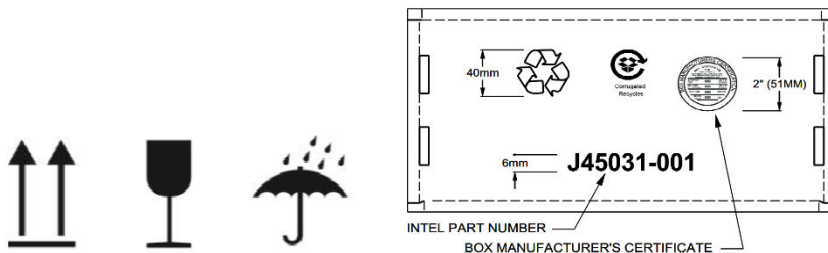
The Intel® Wireless-AC 3165 SKUs listed in the products affected table below will undergo the following changes:

1. Merge Carton label and CE Mark label
2. Carton Box artwork change, update the international symbols & recycling symbols

Before:



After:



3. Add Argentina ID C-14446 into box label
4. The Intel Tracking revision will be changed on the following products:

SKU	Before	After
3165.NGWG	0F	0G

Product Code	Before	After
3165.NGWG	<p>Model: 3165NGW CMIIT ID: 2015AJ0240 (M) Intel® Dual Band Wireless-AC 3165 FCC ID: PD93165NG IC: 1000M-3165NG WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 806723-001 0F TA: XXXXXX-XXX</p>	<p>Model: 3165NGW CMIIT ID: 2015AJ0240 (M) Intel® Dual Band Wireless-AC 3165 FCC ID: PD93165NG IC: 1000M-3165NG WFM: OOOOOOMMMMMM BDM: OOOOOOMMMMMM SPS: 806723-001 0G TA: XXXXXX-XXX</p>

3165.NGWG Carton Label:

Before	<p>3165.NGWG QTY: 100</p> <p>VERSION #: XXXXXX-XXX MADE IN COUNTRY WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p> <p>MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS</p> <p>1 88334 00140 2 9 310779 300005</p>	<p>Official Intel® Product Name (Model: XXXXXX)</p> <p>X-XXX-XXX-XX MANUFACTURER NAME</p> <p>T P/N: GTTTTTTTTTT Packaging ID: XXXXXXXX Revision: 0F</p> <p>PACKAGE WEIGHT: X.X LBS Cust. Part No: XXXXXX-XXX</p> <p>MSP-CRM-INT-XXXXXXXXX</p>
	<p>3165.NGWG QTY: 100</p> <p>VERSION #: XXXXXX-XXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p> <p>MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS</p> <p>1 88334 00140 2 9 310779 300005</p> <p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXX)</p> <p>PKG ID (S) VVVVMMMDDD#####PPPPP100 T P/N: GTTTTTTTTTT</p> <p>D P/N: P P P P P P REV AX X HP P/N: XXXXXX-XXX REV: 0G PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id L P/N: XXXXXXXXXXXX VVVVVLLLLL EC: XXXXXXXX</p>	<p>Complies with EMI Standards DB 02941</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95058-1548 USA www.intel.com</p> <p>CNC CNC ID: C-14448 CNC ID: C-14449</p> <p>MSP-CRM-INT-XXXXXX</p>
After		

3165.NGWG.S Carton Label:

Before	3165.NGWG.S VERSION #: XXXXXX-XXX MADE IN COUNTRY WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXX			QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Official Intel® Product Name (Model: XXXXXX) X-XXX-XXX-XX T P/N: GTTTTTTTTTT PACKAGE WEIGHT: X.X LBS Cust. Part No: XXXXXX-XXX	MANUFACTURER NAME Packaging ID: XXXXXXXX Revision: XX Complies with EIA Standards DB-02941 E178882 MSIP-CRM-INT-XXXXXXXXX
	After	3165.NGWG.S VERSION #: XXXXXX-XXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXX			QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC XXXX (Model: XXXXXX) PKG ID (S) VVVVMMMMDDDD###PPPPPP100 T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AXX HP P/N: XXXXXX-XXX REV: XX L P/N: XXXXXXXXXX EC: XXXXXXXXX

Customer Impact of Change and Recommended Action:

The label change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing

Milestone dates are estimates and subject to change based on business and operational conditions. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
3165.NGWG	940106	H71304-008	H71304-009
3165.NGWG.S	940107	H72060-006	H72060-007

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 26, 2018	00	Originally Published PCN



Product Change Notification

116325 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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